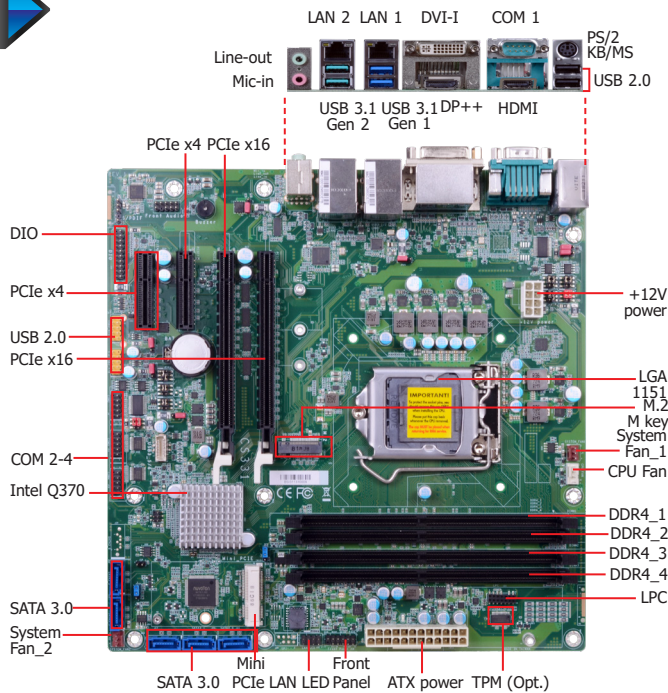


CS331-Q370

Desktop

Q370

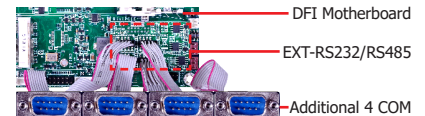


▶ Features

- 4 DDR4 DIMM up to 128GB
- Three display ports: DVI-D, DP++, HDMI (HDMI 2.0a opt.) Supports triple independent displays
- DP++ resolution up to 4096x2160 @ 60Hz
DVI-D resolution up to 1920x1200 @ 60Hz
HDMI 1.2 resolution up to 1920x1200 @ 60Hz
HDMI 2.0a (opt.) resolution up to 4096x2160 @ 60Hz
- Multiple expansion: 2 PCIe x16 (1 x16 or 2 x8 signal), 2 PCIe x4, 1 mini PCIe, 1 M.2 M key (support Optane Memory)
- Rich I/O: 2 Intel GbE, 4 COM, 4 USB 3.1 Gen 2, 2 USB 3.1 Gen 1, 6 USB 2.0



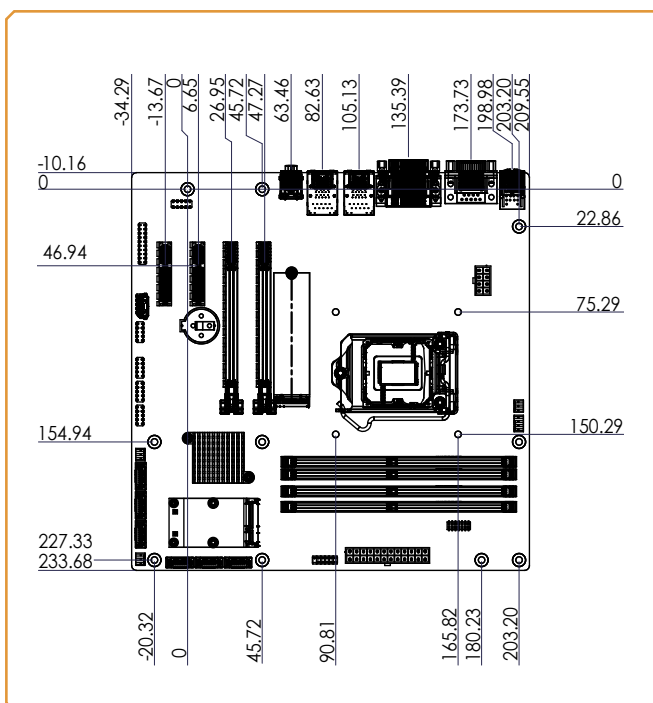
2 Extension Modules for Additional 4 COM Ports (via the LPC connector)



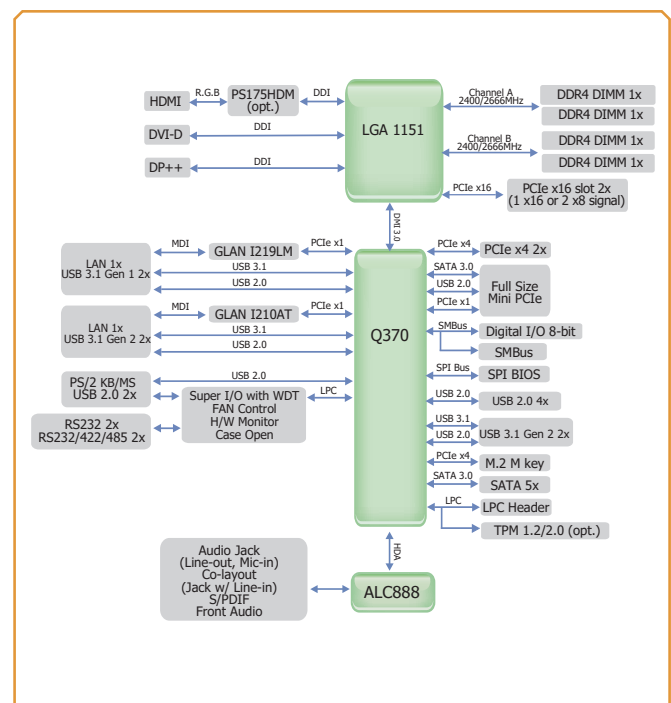
▶ Ordering Information

Model Name	P/N	Memory	GbE	RS-232/ 422/485	RS-232	USB 3.1 Gen 2	USB 3.1 Gen 1	USB 2.0	TPM 2.0	Power	Thermal	Temp.
CS331-Q370NRM	770-CS3311-100G	4 DIMM	2	2	2	4	2	6	0	24-pin ATX/8-pin ATX 12V	Active	0 to 60°C
CS331-Q370NRM	770-CS3311-300G	4 DIMM	2	2	2	4	2	6	1	24-pin ATX/8-pin ATX 12V	Active	0 to 60°C

Mechanical Drawing



▶ Block Diagram



Specifications

SYSTEM	Processor	8th Generation Intel® Core™ /Pentium®/Celeron® LGA 1151 Socket Processors: Intel® Core™ i7-8700 (6 Cores, 12M Cache, up to 4.6 GHz); 65W Intel® Core™ i7-8700T (6 Cores, 12M Cache, up to 4.0 GHz); 35W Intel® Core™ i5-8500 (6 Cores, 9M Cache, up to 4.1 GHz); 65W Intel® Core™ i5-8500T (6 Cores, 9M Cache, up to 3.5 GHz); 35W Intel® Core™ i3-8100 (4 Cores, 6M Cache, 3.6 GHz); 65W Intel® Core™ i3-8100T (4 Cores, 6M Cache, to 3.1 GHz); 35W Intel® Pentium® G5400 (2 Cores, 4M Cache, 3.7 GHz); 58W Intel® Pentium® G5400T (2 Cores, 4M Cache, 3.1 GHz); 35W Intel® Celeron® G4900 (2 Cores, 2M Cache, 3.1 GHz); 54W Intel® Celeron® G4900T (2 Cores, 2M Cache, 2.9 GHz); 35W		9th Generation Intel® Core™ LGA 1151 Socket Processors: Intel® Core™ i7-9700TE (8 Cores, 12M Cache, up to 3.8 GHz); 35W Intel® Core™ i5-9500E (6 Cores, 9M Cache, up to 4.2 GHz); 65W Intel® Core™ i5-9500TE (6 Cores, 9M Cache, up to 3.6 GHz); 35W Intel® Core™ i3-9100E (4 Cores, 6M Cache, 3.7 GHz); 65W Intel® Core™ i3-9100TE (4 Cores, 6M Cache, to 3.2 GHz); 35W	
	Chipset	Intel® Q370 Chipset			
	Memory	Four 288-pin DIMM up to 128GB Dual Channel DDR4 2400/2666 MHz (non ECC support)			
	BIOS	AMI SPI 128Mbit			
GRAPHICS	Controller	Intel® HD Gen 9 Graphics			
	Feature	OpenGL 5.0, DirectX 12, OpenCL 2.1 HW Decode: AVC/H.264, MPEG2, VC1/WMV9, JPEG/MJPEG, HEVC/H265, VP8, VP9 HW Encode: MPEG2, AVC/H264, JPEG, HEVC/H265, VP8, VP9			
	Display	1 x HDMI 1 x DVI-I (DVI-D signal) 1 x DP++ HDMI 1.2: resolution up to 1920x1200 @ 60Hz HDMI 2.0a: resolution up to 4096x2160 @ 60Hz (opt.)(MOQ required) DVI-D: resolution up to 1920x1200 @ 60Hz DP++: resolution up to 4096x2106 @ 60Hz			
	Triple Displays	DVI-D + HDMI + DP++			
EXPANSION	Interface	2 x PCIe x16 (Gen 3) (1 x16 signals or 2 x8 signals) 2 x PCIe x4 (Gen 3) 1 x mini PCIe (PCIe/mSATA/USB2.0) 1 x M.2 2242/2260/2280 M key (PCIe Gen3 x 4 NVMe)			
AUDIO	Audio Codec	Realtek ALC888			
ETHERNET	Controller	1 x Intel® i219LM PCIe (10/100/1000Mbps) with iAMT 12.0 (only Core i7/i5 supports iAMT) 1 x Intel® i210AT PCIe (10/100/1000Mbps)			
REAR I/O	Ethernet	2 x GbE (RJ-45)			
	USB	2 x USB 3.1 Gen 2 2 x USB 3.1 Gen 1 2 x USB 2.0			
	Serial	1 x RS-232/422/485 (RS-232 w/ power) (DB-9)			
	PS/2	1 x PS/2 (mini-DIN-6)			
	Display	1 x HDMI 1 x DVI-I (DVI-D signal) 1 x DP++			
	Audio	1 x Line-out 1 x Mic-in 1 x Line-in (colay, opt. by request, MOQ required)			
	INTERNAL I/O	Serial	1 x RS-232/422/485 (RS-232 w/ power) (2.54mm pitch) 2 x RS-232		
	USB	2 x USB 3.1 Gen 2 4 x USB 2.0 (2.54mm pitch) (1 x USB 2.0 colay vertical Type A) (opt. by request, MOQ required)			
	Audio	1 x S/PDIF, 1 x Front Audio Header			
	SATA	5 x SATA 3.0 (up to 6Gb/s) RAID 0/1/5/10			
	DIO	1 x 8-bit DIO			
	LPC	1 x LPC (support LPC EXT-RS-232/485 module)			
	SMBus	1 x SMBus			
	WATCHDOG TIMER	Output & Interval	System Reset, Programmable via Software from 1 to 255 sec/min		
SECURITY	TPM	Infineon TPM 1.2/2.0 (Available Upon Request, MOQ required)			
POWER	Type	ATX			
	Connector	8-pin ATX 12V power 24-pin ATX power			
	Consumption	Typical: i7-8700K: 3.3V @ 0.13A (0.429Watt); 5V @ 0.46A (2.3Watt); 12V @ 0.31A (3.72Watt) Max.: i7-8700K: 3.3V @ 0.22A (0.726Watt); 5V @ 1.21A (6.05Watt); 12V @ 11.31A (135.72Watt)			
	RTC Battery	CR2032 Coin Cell			
OS SUPPORT		Windows 10 IoT Enterprise 64-bit Linux			
ENVIRONMENT	Temperature	Operating: 0 to 60°C Storage: -30 to 60°C with RTC Battery; -40 to 85°C without RTC Battery			
	Humidity	Operating: 5 to 90% RH Storage: 5 to 90% RH			
	MTBF	554,887 hrs @ 25°C; 312,271 hrs @ 45°C ; 193,870 hrs @ 60°C Calculation Model: Telcordia Issue 4 Environment: GB, GC - Ground Benign, Controlled			
MECHANICAL	Dimensions	microATX form factor 244mm (9.6") x 244mm (9.6")			
	Height	PCB: 1.6mm Top Side: 31.51mm, Bottom Side: 4.4mm			
CERTIFICATIONS		CE, FCC, RoHS, KCC			

Packing List

• 1 CS331-Q370 motherboard	
• 1 COM port cable (W/Bracket, Length: 300mm, 2 x COM ports)	A81-015026-023G
• 1 Serial ATA data cable (W/LOCK, Length: 500mm)	332-553001-005G
• 1 I/O shield	A49-CS3311-001G
• 1 M.2 2242/2260/half mini PCIe standoff	A33-725019-090G
• 2 M.2 Screw	A32-112016-041G

Optional Items

• USB 2.0 port cable (Length: 350mm)	A81-001066-016G
• USB 3.1 Gen 2 port cable (Length: 300mm)	A81-001075-017G
• COM port cable (Length: 300mm, 2 x COM ports)	A81-015026-023G
• Serial ATA data cable (Length: 500mm, W/LOCK)	332-553001-005G
• Thermal solution (For 35W, Height: 37.3mm)	A71-101107-000G
• Thermal solution (For 65W, Height: 74.47mm)	A71-101158-000G
• Thermal solution (For 95W, Height: 76.6mm)	A71-101143-000G
• LPC EXT-RS232 module (4 x RS232 ports)	770-EXTRS1-000G
• LPC EXT-RS485 module (4 x RS485 ports)	770-EXTRS1-100G
• DP to HDMI Dongle	612-D2H13M-000G